

Feature

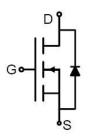
20V,80A

$$\begin{split} R_{DS~(ON)} <& 6m~\Omega~@V_{GS} = 4.5V \\ R_{DS~(ON)} <& 10m~\Omega~@V_{GS} = 2.5V \end{split}$$

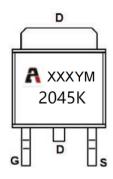
- Advanced Trench Technology
- Lead free product is acquired
- Excellent R DS (ON) and Low Gate Charge

Application

- PWM applications
- Load Switch
- Power management



Schematic Diagram



Marking and pin assignment

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
2045K	AP2045K	TO-252	-	-	2500

ABSOLUTE MAXIMUM RATINGS (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current (T _C =25℃)	I _D	80	Α
Continuous Drain Current (T _C =100℃)	I _D	51	Α
Pulsed Drain Currenr (1)	I _{DM}	300	Α
Singel Pulsed Avalanche Energy (2)	E _{AS}	57	mJ
Power Dissipation	P _D	57	W
Thermal Resistance from Junction to Case	R _{θJC}	2.63	°C/W
Junction Temperature	TJ	150	$^{\circ}$
Storage Temperature	T _{STG}	-55~ +150	$^{\circ}$ C



MOSFET ELECTRICAL CHARACTERISTICS(T_J=25℃ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	20	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =20V, V _{GS} = 0V	-	-	1	μΑ
Gate-body leakage current	I _{GSS}	V_{GS} = \pm 12V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage ⁽³⁾	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =250μA	0.4	0.7	1.2	V
Drain-source on-resistance ⁽³⁾	R _{DS(on)}	V _{GS} =4.5V, I _D =30A	-	4.0	6	mΩ
Diam-source on-resistance		V _{GS} =2.5V, I _D =20A	-	6.5	10	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =10V, V _{GS} =0V, f =1MHz	-	2500	-	pF
Output Capacitance	Coss		-	407	-	
Reverse Transfer Capacitance	C _{rss}		-	386	-	
Switching characteristics						
Turn-on delay time	t _{d(on)}		-	17	-	- ns
Turn-on rise time	t _r	V_{DD} =10V, I_{D} =30A, R_{L} =3.3 Ω V_{GS} =4.5V, R_{G} =3 Ω	-	49	-	
Turn-off delay time	t _{d(off)}		_	74	-	
Turn-off fall time	t _f		-	26	-	
Total Gate Charge	Qg	VDS=10V, ID=30A, VGS=4.5V	-	32	-	nC
Gate-Source Charge	Qgs		-	3	-	
Gate-Drain Charge	Qgd	V GG-4.0V	-	11	•	
Source-Drain Diode characteristics						
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =30A	-	-	1.2	V
Diode Forward current ⁽⁴⁾	Is		-	-	80	Α

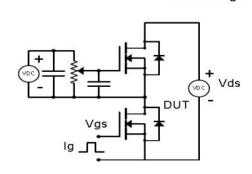
Notes:

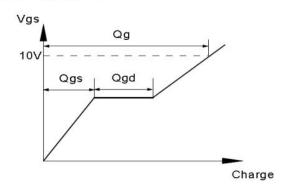
- 1. Repetitive Rating: pulse width limited by maximum junction temperature
- 2. EAS Condition: T_J =25°C, V_{DD} =10V, R_G =25 Ω ,L=0.5mH
- 3. Pulse Test: pulse width≤300µs, duty cycle≤2%
- 4. Surface Mounted on FR4 Board,t≤10 sec



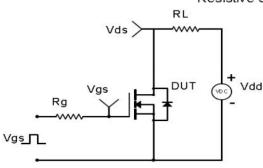
Test Circuit & Waveform

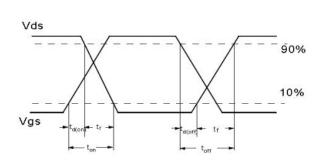
Gate Charge Test Circuit & Waveform



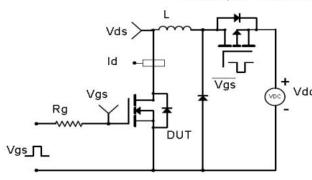


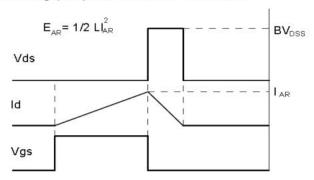
Resistive Switching Test Circuit & Waveforms



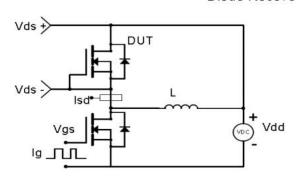


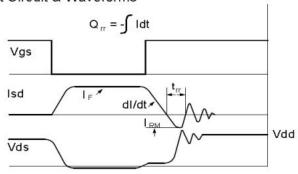
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms







Typical Performance Characteristics

Figure1: Output Characteristics

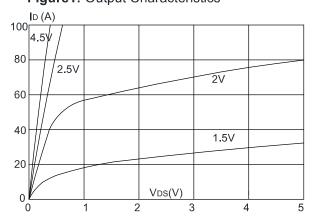


Figure 3:On-resistance vs. Drain Current

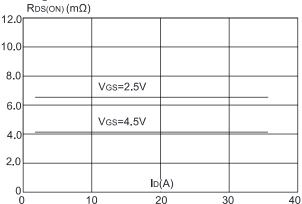


Figure 5: Gate Charge Characteristics

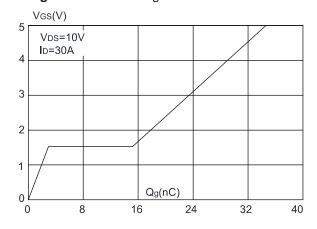


Figure 2: Typical Transfer Characteristics

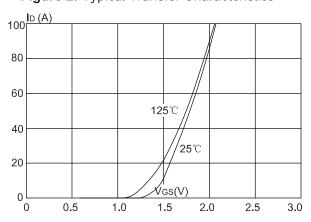


Figure 4: Body Diode Characteristics

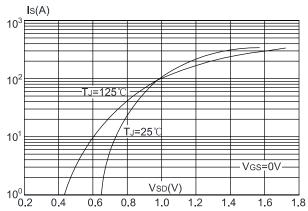
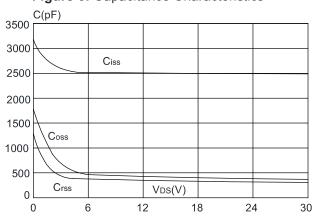


Figure 6: Capacitance Characteristics





DATA SHEET

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

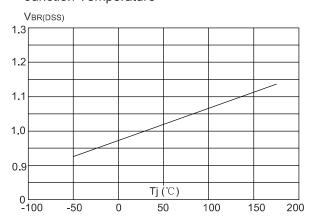


Figure 9: Maximum Safe Operating Area

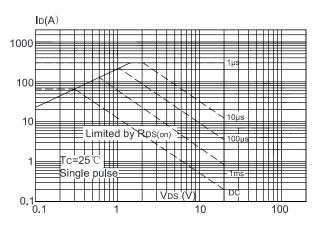


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

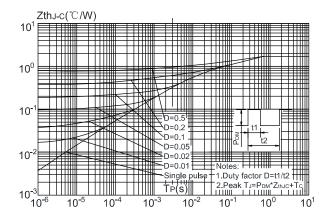


Figure 8: Normalized on Resistance vs. Junction Temperature

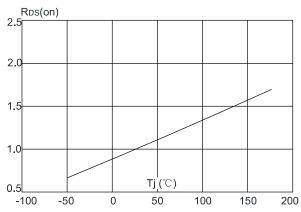
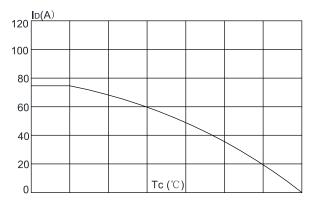
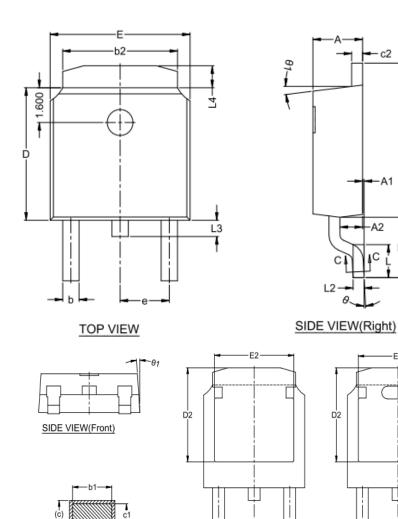


Figure 10: Maximum Continuous Drain Current vs. Case Temperature



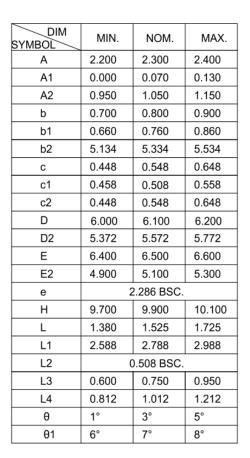


TO-252 Package Information



OPTION 1

BOTTOM VIEW



SECTION:C-C

OPTION 2

BOTTOM VIEW

c2



Revision History

Revision	Release	Remark
V1.0	2024/05/18	Initial Release

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Allpower assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which

requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.